

Replaces DS5547-4

DIM1200FSM12-A000

Single Switch IGBT Module

DS5547-5 July 2014 (LN31765)

FEATURES

- 10µs Short Circuit Withstand
- High Thermal Cycling Capability
- Non Punch Through Silicon
- Isolated AISiC Base with AIN Substrates
- Lead Free construction

APPLICATIONS

- High Reliability Inverters
- Motor Controllers
- Traction Drives

The Powerline range of high power modules includes half bridge, chopper, dual, single and bi-directional switch configurations covering voltages from 1200V to 6500V and currents up to 2400A.

The DIM1200FSM12-A000 is a single switch 1200V, n-channel enhancement mode, insulated gate bipolar transistor (IGBT) module. The IGBT has a wide reverse bias safe operating area (RBSOA) plus 10µs short circuit withstand. This device is optimised for traction drives and other applications requiring high thermal cycling capability.

The module incorporates an electrically isolated base plate and low inductance construction enabling circuit designers to optimise circuit layouts and utilise grounded heat sinks for safety.

ORDERING INFORMATION

Order As:

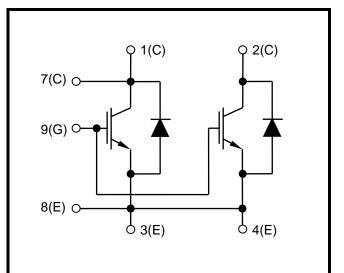
DIM1200FSM12-A000

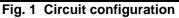
Note: When ordering, please use the complete part number

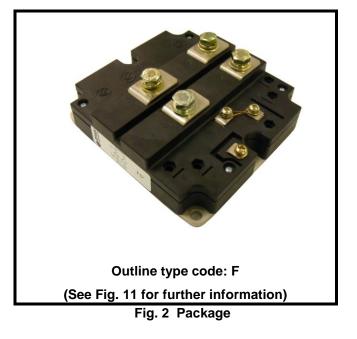
KEY PARAMETERS

V _{CES}		1200V
V _{CE(sat)} *	f (typ)	2.2V
l _c `́	(max)	1200A
I _{C(PK)}	(max)	2400A

* Measured at the power busbars, not the auxiliary terminals







ABSOLUTE MAXIMUM RATINGS

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed. Exposure to Absolute Maximum Ratings may affect device reliability.

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
V _{CES}	Collector-emitter voltage	$V_{GE} = 0V$	1200	V
V_{GES}	Gate-emitter voltage		±20	V
Ι _C	Continuous collector current	T _{case} = 85°C	1200	А
I _{C(PK)}	Peak collector current	1ms, T _{case} = 110°C	2400	А
P _{max}	Max. transistor power dissipation	$T_{case} = 25^{\circ}C, T_j = 150^{\circ}C$	10400	W
l ² t	Diode I ² t value	$V_R = 0, t_p = 10ms, T_j = 125^{o}C$	400	kA ² s
V _{isol}	Isolation voltage – per module	Commoned terminals to base plate. AC RMS, 1 min, 50Hz	2500	V
Q _{PD}	Partial discharge – per module	IEC1287, $V_1 = 1300V$, $V_2 = 1000V$, 50Hz RMS	10	рС

THERMAL AND MECHANICAL RATINGS

Internal insulation material:	AIN
Baseplate material:	AISiC
Creepage distance:	20mm
Clearance:	10mm
CTI (Comparative Tracking Index):	>600

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
R _{th(j-c)}	Thermal resistance – transistor	Continuous dissipation - junction to case	-	-	12	°C/kW
R _{th(j-c)}	Thermal resistance – diode	Continuous dissipation - junction to case	-	-	20	°C/kW
R _{th(c-h)}	Thermal resistance – case to heatsink (per module)	Mounting torque 5Nm (with mounting grease)	-	-	8	°C/kW
Tj	Junction temperature	Transistor	-	-	150	°C
		Diode	-	-	125	°C
T _{stg}	Storage temperature range	-	-40	-	125	°C
		Mounting – M6	-	-	5	Nm
	Screw torque	Electrical connections – M4	-	-	2	Nm
		Electrical connections – M8	-	-	10	Nm

ELECTRICAL CHARACTERISTICS

T_{case} = 25°C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
		$V_{GE} = 0V, V_{CE} = V_{CES}$			1.5	mA
I _{CES}	Collector cut-off current	$V_{GE} = 0V, V_{CE} = V_{CES}, T_{case} = 125^{\circ}C$			40	mA
I _{GES}	Gate leakage current	$V_{GE} = \pm 20V, V_{CE} = 0V$			6	μA
V _{GE(TH)}	Gate threshold voltage	$I_{C} = 60 \text{mA}, V_{GE} = V_{CE}$	4.5	5.5	6.5	V
M	Collector-emitter	V _{GE} = 15V, I _C = 1200A		2.2	2.8	V
V _{CE(sat)}	saturation voltage	V _{GE} = 15V, I _C = 1200A, T _j = 125°C		2.6	3.2	V
I _F	Diode forward current	DC			1200	А
I _{FM}	Diode maximum forward current	t _p = 1ms			2400	А
	Diada farward welfare	I _F = 1200A		1.9	2.1	V
V_{F}	Diode forward voltage	I _F = 1200A, T _j = 125°C		1.8	2.1	V
C _{ies}	Input capacitance	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$		135		nF
Qg	Gate charge	±15V		12		μC
C _{res}	Reverse transfer capacitance	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz				nF
L _M	Module inductance			15		nH
R _{INT}	Internal transistor resistance			140		μΩ
SC _{Data}	Short circuit current, I _{SC}	$T_j = 125^{\circ}C, V_{CC} = 900V$ $t_p \le 10\mu s, V_{GE} \le 15V$ $V_{CE (max)} = V_{CES} - L^* x dI/dt$ IEC 60747-9		7000		A

Note:

L is the circuit inductance + L_M

Caution: This device is sensitive to electrostatic discharge. Users should follow ESD handling procedures

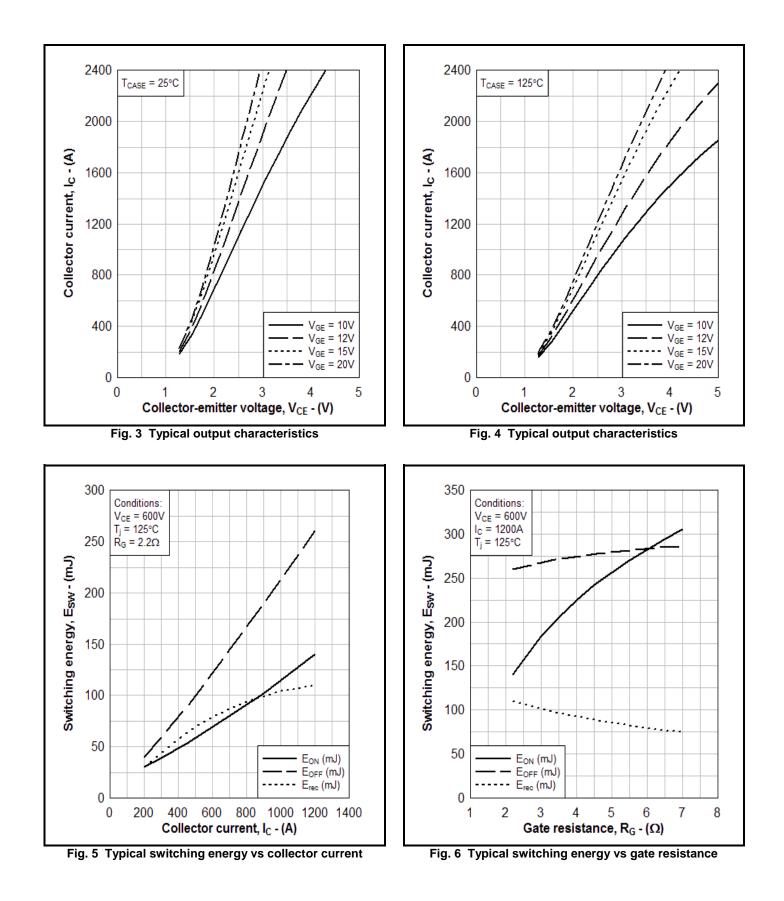
ELECTRICAL CHARACTERISTICS

T_{case} = 25°C unless stated otherwise

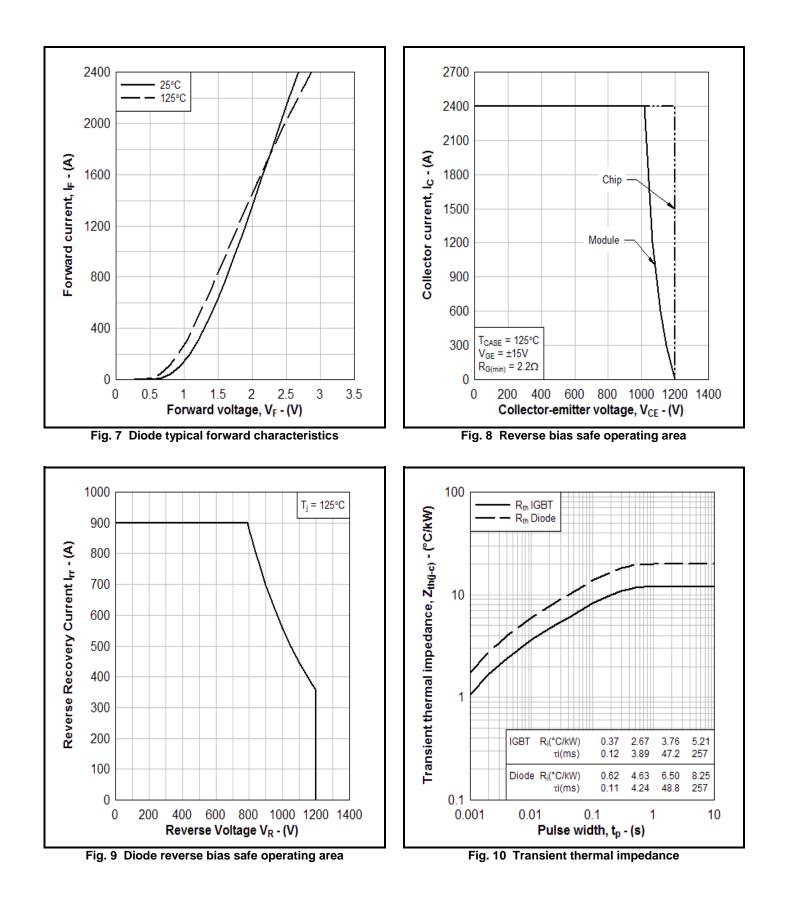
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
t _{d(off)}	Turn-off delay time			1250		ns
t _f	Fall time	I _C = 1200A V _{GE} = ±15V		180		ns
E _{OFF}	Turn-off energy loss	$V_{GE} = \pm 13V$ $V_{CE} = 600V$		160		mJ
t _{d(on)}	Turn-on delay time	$R_{G(ON)} = 2.2\Omega$		250		ns
t _r	Rise time	R _{G(OFF)} = 2.2Ω L _S ~ 100nH		200		ns
E _{ON}	Turn-on energy loss			80		mJ
Q _{rr}	Diode reverse recovery charge	I _F = 1200A		120		μC
I _{rr}	Diode reverse recovery current	$V_{CE} = 600V$		570		А
E _{rec}	Diode reverse recovery energy	dI _F /dt = 6200A/µs		60		mJ

T_{case} = 125°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
t _{d(off)}	Turn-off delay time			1380		ns
t _f	Fall time	$I_{C} = 1200A$ $V_{GE} = \pm 15V$		200		ns
E _{OFF}	Turn-off energy loss	$V_{GE} = \pm 13V$ $V_{CE} = 600V$		260		mJ
t _{d(on)}	Turn-on delay time	$R_{G(ON)} = 2.2\Omega$		350		ns
t _r	Rise time	$R_{G(OFF)} = 2.2\Omega$ L _S ~ 100nH		220		ns
E _{ON}	Turn-on energy loss			140		mJ
Q _{rr}	Diode reverse recovery charge	I _F = 1200A		240		μC
I _{rr}	Diode reverse recovery current	$V_{CE} = 600V$		680		А
E _{rec}	Diode reverse recovery energy	dI _F /dt = 5700A/µs		110		mJ



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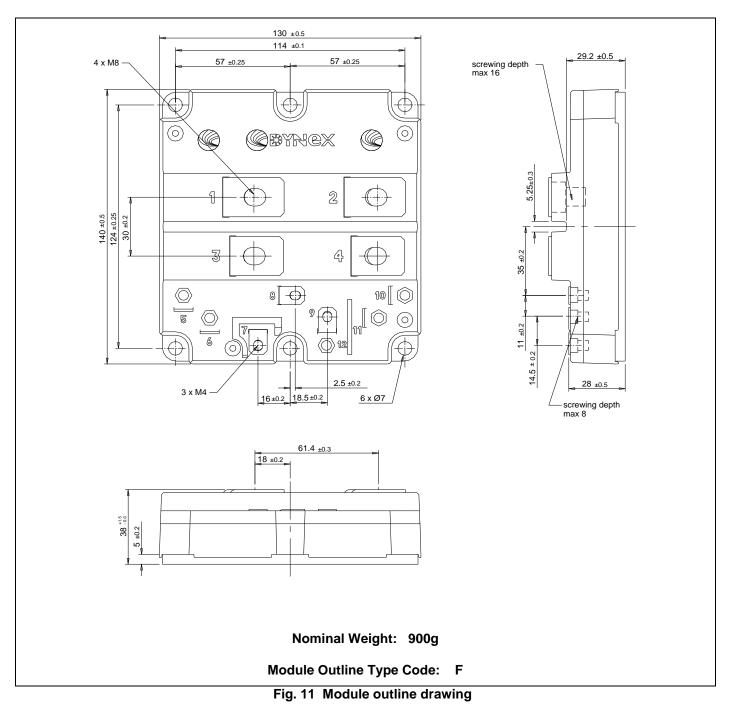


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PACKAGE DETAILS

For further package information, please visit our website or contact Customer Services. All dimensions in mm, unless stated otherwise. **DO NOT SCALE.**



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